Renesas Electronics America Inc - UPD78F0494GK-GAK-AX Datasheet

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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	78K/0
Core Size	8-Bit
Speed	10MHz
Connectivity	3-Wire SIO, LINbus, UART/USART
Peripherals	LCD, LVD, POR, PWM, WDT
Number of I/O	62
Program Memory Size	48KB (48K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	2K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 5.5V
Data Converters	A/D 8x10b, 3x16b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	80-LQFP
Supplier Device Package	-
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/upd78f0494gk-gak-ax

NOTES FOR CMOS DEVICES

① VOLTAGE APPLICATION WAVEFORM AT INPUT PIN

Waveform distortion due to input noise or a reflected wave may cause malfunction. If the input of the CMOS device stays in the area between V_{IL} (MAX) and V_{IH} (MIN) due to noise, etc., the device may malfunction. Take care to prevent chattering noise from entering the device when the input level is fixed, and also in the transition period when the input level passes through the area between V_{IL} (MAX) and V_{IH} (MIN).

② HANDLING OF UNUSED INPUT PINS

Unconnected CMOS device inputs can be cause of malfunction. If an input pin is unconnected, it is possible that an internal input level may be generated due to noise, etc., causing malfunction. CMOS devices behave differently than Bipolar or NMOS devices. Input levels of CMOS devices must be fixed high or low by using pull-up or pull-down circuitry. Each unused pin should be connected to V_{DD} or GND via a resistor if there is a possibility that it will be an output pin. All handling related to unused pins must be judged separately for each device and according to related specifications governing the device.

③ PRECAUTION AGAINST ESD

A strong electric field, when exposed to a MOS device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop generation of static electricity as much as possible, and quickly dissipate it when it has occurred. Environmental control must be adequate. When it is dry, a humidifier should be used. It is recommended to avoid using insulators that easily build up static electricity. Semiconductor devices must be stored and transported in an anti-static container, static shielding bag or conductive material. All test and measurement tools including work benches and floors should be grounded. The operator should be grounded using a wrist strap. Semiconductor devices must not be touched with bare hands. Similar precautions need to be taken for PW boards with mounted semiconductor devices.

④ STATUS BEFORE INITIALIZATION

Power-on does not necessarily define the initial status of a MOS device. Immediately after the power source is turned ON, devices with reset functions have not yet been initialized. Hence, power-on does not guarantee output pin levels, I/O settings or contents of registers. A device is not initialized until the reset signal is received. A reset operation must be executed immediately after power-on for devices with reset functions.

⑤ POWER ON/OFF SEQUENCE

In the case of a device that uses different power supplies for the internal operation and external interface, as a rule, switch on the external power supply after switching on the internal power supply. When switching the power supply off, as a rule, switch off the external power supply and then the internal power supply. Use of the reverse power on/off sequences may result in the application of an overvoltage to the internal elements of the device, causing malfunction and degradation of internal elements due to the passage of an abnormal current.

The correct power on/off sequence must be judged separately for each device and according to related specifications governing the device.

⑥ INPUT OF SIGNAL DURING POWER OFF STATE

Do not input signals or an I/O pull-up power supply while the device is not powered. The current injection that results from input of such a signal or I/O pull-up power supply may cause malfunction and the abnormal current that passes in the device at this time may cause degradation of internal elements.

Input of signals during the power off state must be judged separately for each device and according to related specifications governing the device.

Figure 3-19. Correspondence Between Data Memory and Addressing (μPD78F0475, 78F0485)

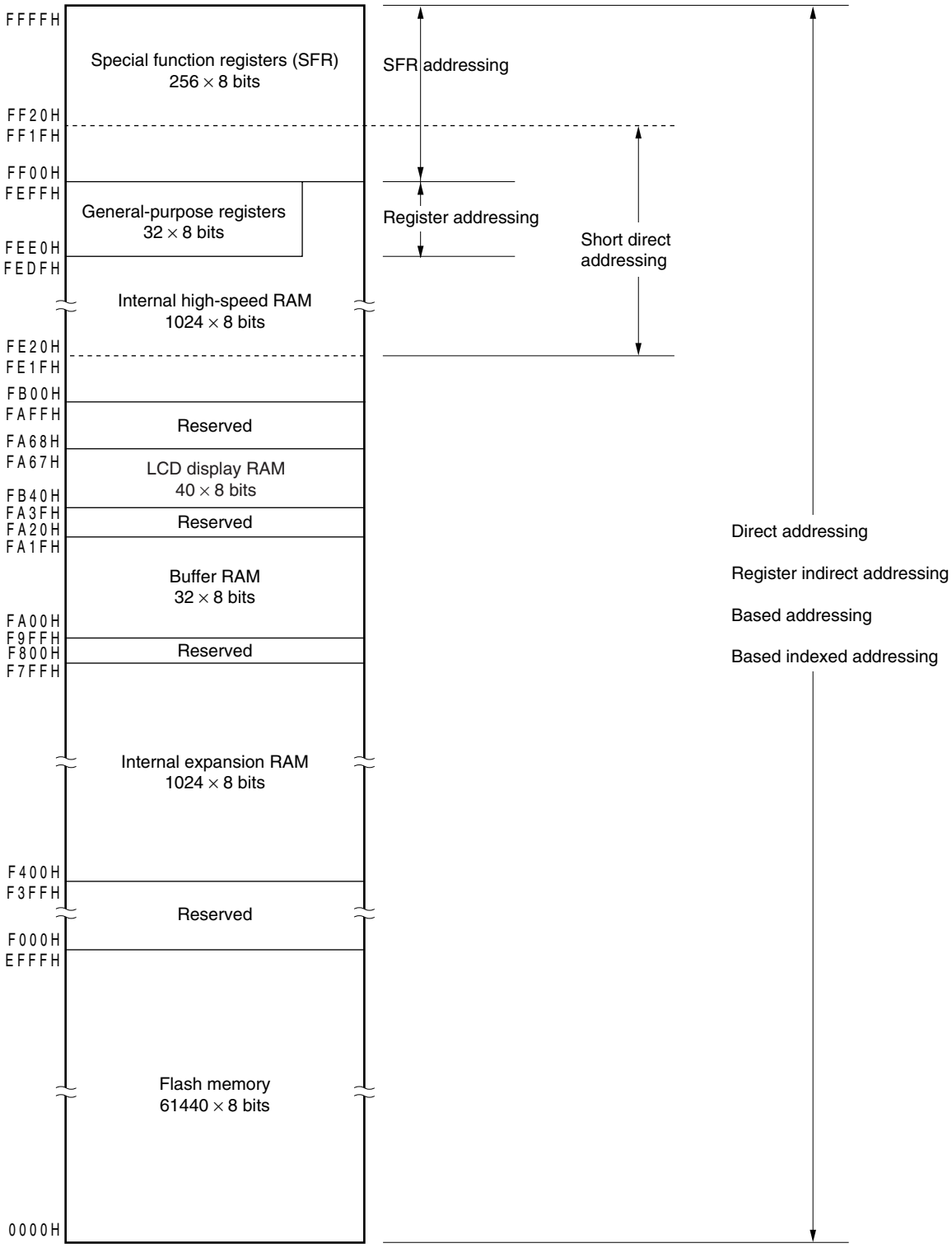
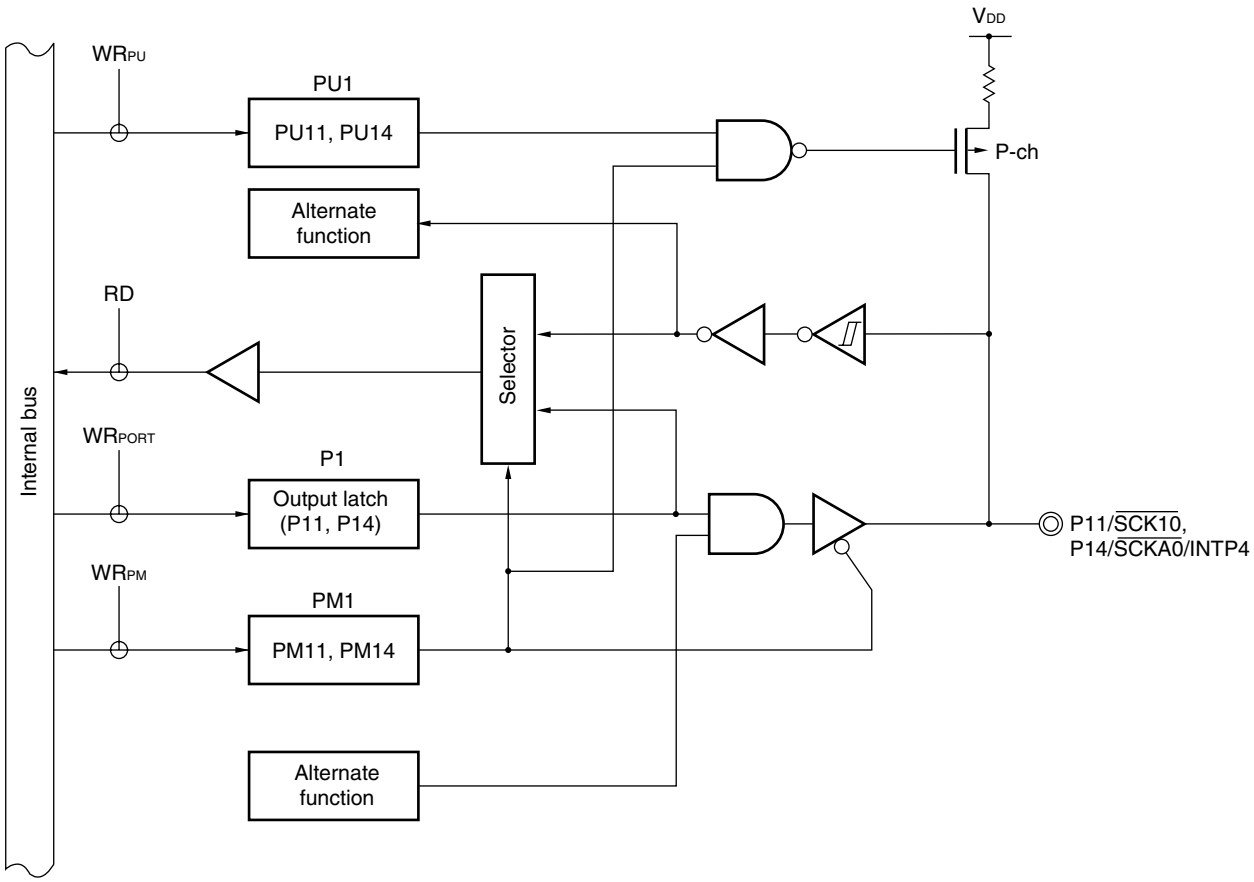


Figure 4-3. Block Diagram of P11 and P14



P1: Port register 1
PU1: Pull-up resistor option register 1
PM1: Port mode register 1
RD: Read signal
WR××: Write signal

(4) Internal oscillation mode register (RCM)

This register sets the operation mode of internal oscillator.

RCM can be set by a 1-bit or 8-bit memory manipulation instruction.

Reset signal generation sets this register to 80H[Note 1].

Figure 5-4. Format of Internal Oscillation Mode Register (RCM)

Address: FFA0H After reset: 80H[Note 1] R/W[Note 2]

Symbol	<7>	6	5	4	3	2	<1>	<0>
RCM	RSTS	0	0	0	0	0	LSRSTOP	RSTOP

RSTS	Status of internal high-speed oscillator
0	Waiting for accuracy stabilization of internal high-speed oscillator
1	Stability operating of internal high-speed oscillator

LSRSTOP	Internal low-speed oscillator oscillating/stopped
0	Internal low-speed oscillator oscillating
1	Internal low-speed oscillator stopped

RSTOP	Internal high-speed oscillator oscillating/stopped
0	Internal high-speed oscillator oscillating
1	Internal high-speed oscillator stopped

Notes 1. The value of this register is 00H immediately after a reset release but automatically changes to 80H after internal high-speed oscillator has been stabilized.

2. Bit 7 is read-only.

Caution When setting RSTOP to 1, be sure to confirm that the CPU operates with a clock other than the internal high-speed oscillation clock. Specifically, set under either of the following conditions.

- **When MCS = 1 (when CPU operates with the high-speed system clock)**
- **When CLS = 1 (when CPU operates with the subsystem clock)**

In addition, stop peripheral hardware that is operating on the internal high-speed oscillation clock before setting RSTOP to 1.

(5) Main OSC control register (MOC)

This register selects the operation mode of the high-speed system clock.

This register is used to stop the X1 oscillator or to disable an external clock input from the EXCLK pin when the CPU operates with a clock other than the high-speed system clock.

MOC can be set by a 1-bit or 8-bit memory manipulation instruction.

Reset signal generation sets this register to 80H.

Figure 5-5. Format of Main OSC Control Register (MOC)

Address: FFA2H After reset: 80H R/W

Symbol	<7>	6	5	4	3	2	1	0
MOC	MSTOP	0	0	0	0	0	0	0

MSTOP	Control of high-speed system clock operation	
	X1 oscillation mode	External clock input mode
0	X1 oscillator operating	External clock from EXCLK pin is enabled
1	X1 oscillator stopped	External clock from EXCLK pin is disabled

Cautions 1. When setting MSTOP to 1, be sure to confirm that the CPU operates with a clock other than the high-speed system clock. Specifically, set under either of the following conditions.

- **When MCS = 0 (when CPU operates with the internal high-speed oscillation clock)**
- **When CLS = 1 (when CPU operates with the subsystem clock)**

In addition, stop peripheral hardware that is operating on the high-speed system clock before setting MSTOP to 1.

2. Do not clear MSTOP to 0 while bit 6 (OSCSEL) of the clock operation mode select register (OSCCTL) is 0 (I/O port mode).

3. The peripheral hardware cannot operate when the peripheral hardware clock is stopped. To resume the operation of the peripheral hardware after the peripheral hardware clock has been stopped, initialize the peripheral hardware.

Figure 7-10. Format of 8-Bit Timer Mode Control Register 51 (TMC51)

Address: FF43H After reset: 00H R/W[Note]

Symbol	<7>	6	5	4	<3>	<2>	1	<0>
TMC51	TCE51	TMC516	0	0	LVS51	LVR51	TMC511	TOE51

TCE51	TM51 count operation control
0	After clearing to 0, count operation disabled (counter stopped)
1	Count operation start

TMC516	TM51 operating mode selection
0	Mode in which clear & start occurs on a match between TM51 and CR51
1	PWM (free-running) mode

LVS51	LVR51	Timer output F/F status setting
0	0	No change
0	1	Timer output F/F clear (0) (default value of TO51 output: low)
1	0	Timer output F/F set (1) (default value of TO51 output: high)
1	1	Setting prohibited

TMC511	In other modes (TMC516 = 0)	In PWM mode (TMC516 = 1)
	Timer F/F control	Active level selection
0	Inversion operation disabled	Active-high
1	Inversion operation enabled	Active-low

TOE51	Timer output control
0	Output disabled (TO51 output is low level)
1	Output enabled

Note Bits 2 and 3 are write-only.

Cautions 1. The settings of LVS5n and LVR5n are valid in other than PWM mode.

2. Perform <1> to <4> below in the following order, not at the same time.

<1> Set TMC5n1, TMC5n6: Operation mode setting

<2> Set TOE5n to enable output: Timer output enable

<3> Set LVS5n, LVR5n (see Caution 1): Timer F/F setting

<4> Set TCE5n

3. When TCE5n = 1, setting the other bits of TMC5n is prohibited.

4. The actual TO50/TI50/P44/KR4 and TO51/TI51/P43/KR3 pin outputs are determined depending on PM44 and P44, and PM43 and P43, besides TO5n output.

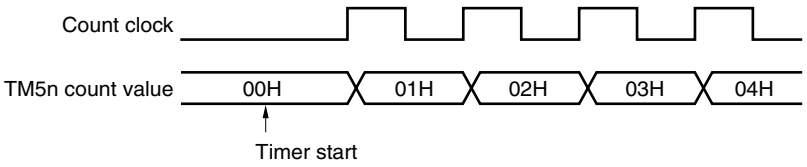
Remarks 1. In PWM mode, PWM output is made inactive by clearing TCE5n to 0.

2. If LVS5n and LVR5n are read, the value is 0.

3. The values of the TMC5n6, LVS5n, LVR5n, TMC5n1, and TOE5n bits are reflected at the TO5n pin regardless of the value of TCE5n.

4. n = 0, 1

Figure 7-20. 8-Bit Timer Counter 5n Start Timing



Remark n = 0 to 2

<R> **(2) Cautions for 16-bit timer/event counter 00 count up during external 24-bit event counter operation**

16-bit timer/event counter 00 has an internal synchronization circuit to eliminate noise when starting operation, and the first clock immediately after operation start is not counted.

When using the counter as a 24-bit counter, by setting 16-bit timer/event counter 00 and 8-bit timer/event counter 52 as the higher and lower timer and connecting them in cascade, the interrupt request flag of 8-bit timer/event counter 52 which is the lower timer must be checked as described below, in order to accurately read the 24-bit count values.

- If TMIF52 = 1 when TM52 and TM00 are read:

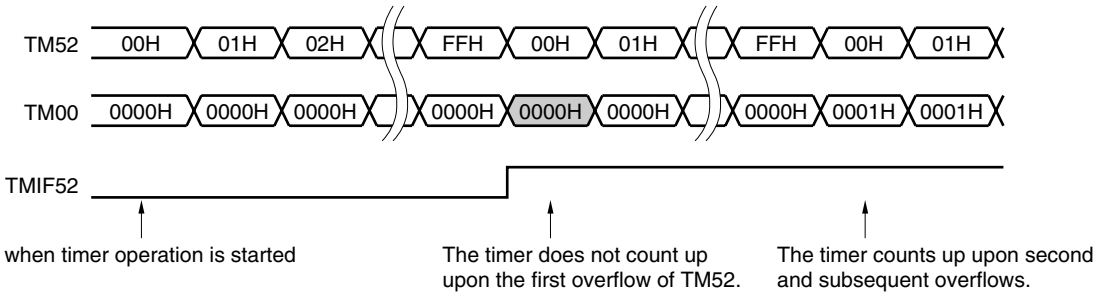
  The actual TM00 count value is “read value of TM00 + 1”.

- If TMIF52 = 0 when TM52 and TM00 are read:

  The read value is the correct value.

This phenomenon of 16-bit timer/event counter 00 occurs only when operation is started. A count delay will not occur when 16-bit timer/event counter 00 overflows and the count is restarted from 0000H, since synchronization has already been implemented.

<When starting operation>



<Overflow of higher timer>

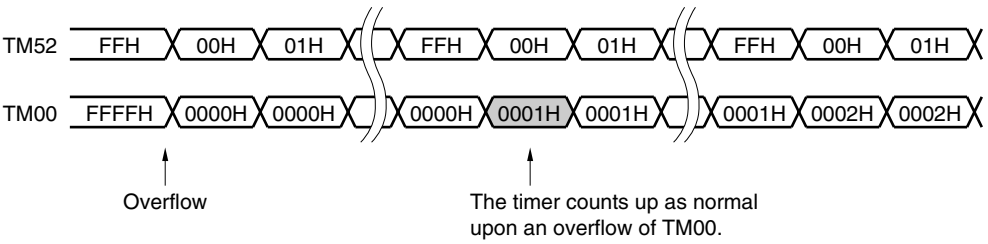
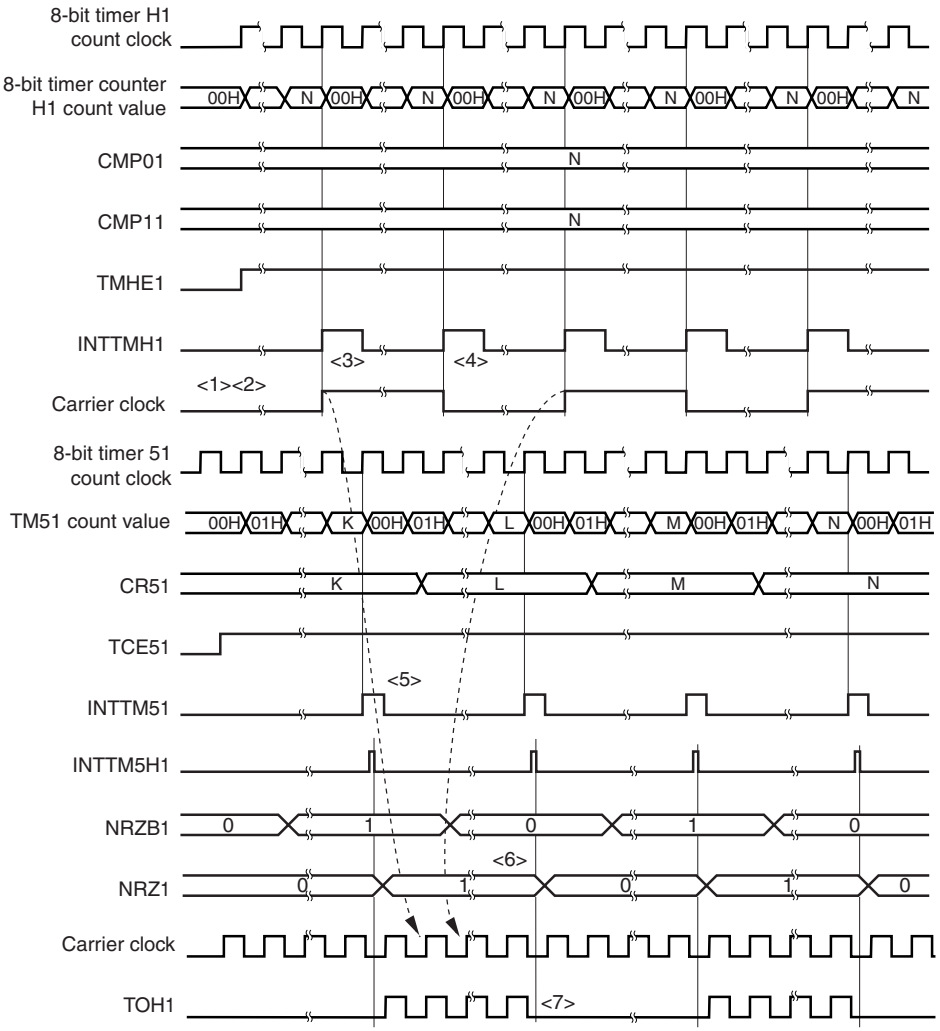


Figure 8-17. Carrier Generator Mode Operation Timing (1/3)

(a) Operation when CMP01 = N, CMP11 = N



<1> When TMHE1 = 0 and TCE51 = 0, the 8-bit timer counter H1 operation is stopped.

<2> When TMHE1 = 1 is set, the 8-bit timer counter H1 starts a count operation. At that time, the carrier clock remains default.

<3> When the count value of the 8-bit timer counter H1 matches the CMP01 register value, the first INTTMH1 signal is generated, the carrier clock signal is inverted, and the compare register to be compared with the 8-bit timer counter H1 is switched from the CMP01 register to the CMP11 register. The 8-bit timer counter H1 is cleared to 00H.

<4> When the count value of the 8-bit timer counter H1 matches the CMP11 register value, the INTTMH1 signal is generated, the carrier clock signal is inverted, and the compare register to be compared with the 8-bit timer counter H1 is switched from the CMP11 register to the CMP01 register. The 8-bit timer counter H1 is cleared to 00H. By performing procedures <3> and <4> repeatedly, a carrier clock with duty fixed to 50% is generated.

<5> When the INTTM51 signal is generated, it is synchronized with the 8-bit timer H1 count clock and is output as the INTTM5H1 signal.

<6> The INTTM5H1 signal becomes the data transfer signal for the NRZB1 bit, and the NRZB1 bit value is transferred to the NRZ1 bit.

<7> When NRZ1 = 0 is set, the TOH1 output becomes low level.

Remark INTTM5H1 is an internal signal and not an interrupt source.

Figure 9-3. Format of Real-Time Counter Control Register 0 (RTCC0)

Address: FF89H After reset: 00H R/W

Symbol	<7>	6	<5>	<4>	3	2	1	0
RTCC0	RTCE	0	RCLOE1	RCLOE0	AMPM	CT2	CT1	CT0

RTCE	Real-time counter operation control
0	Stops counter operation.
1	Starts counter operation.

RCLOE1	RTC1HZ pin output control
0	Disables output of RTC1HZ pin (1 Hz).
1	Enables output of RTC1HZ pin (1 Hz).

RCLOE0[Note]	RTCCL pin output control
0	Disables output of RTCCL pin (32.768 kHz).
1	Enables output of RTCCL pin (32.768 kHz).

AMPM	Selection of 12-/24-hour system
0	12-hour system (a.m. and p.m. are displayed.)
1	24-hour system
• To change the value of AMPM, set RWAIT (bit 0 of RTCC1) to 1, and re-set the hour count register (HOUR). • Table 9-2 shows the displayed time digits.	

CT2	CT1	CT0	Constant-period interrupt (INTRTC) selection
0	0	0	Does not use constant-period interrupt function.
0	0	1	Once per 0.5 s (synchronized with second count up)
0	1	0	Once per 1 s (same time as second count up)
0	1	1	Once per 1 m (second 00 of every minute)
1	0	0	Once per 1 hour (minute 00 and second 00 of every hour)
1	0	1	Once per 1 day (hour 00, minute 00, and second 00 of every day)
1	1	×	Once per 1 month (Day 1, hour 00 a.m., minute 00, and second 00 of every month)
After changing the values of CT2 to CT0, clear the interrupt request flag.			

Note RCLOE0 and RCLOE2 must not be enabled at the same time.

Caution If RCLOE0 and RCLOE1 are changed when RTCE = 1, a pulse with a narrow width may be generated on the 32.768 kHz and 1 Hz output signals.

Remark ×: don't care

Figure 9-4. Format of Real-Time Counter Control Register 1 (RTCC1) (2/2)

RWAIT	Wait control of real-time counter
0	Sets counter operation.
1	Stops SEC to YEAR counters. Mode to read or write counter value

This bit controls the operation of the counter.
Be sure to write "1" to it to read or write the counter value.
Because RSUBC continues operation, complete reading or writing of it in 1 second, and clear this bit back to 0.
When RWAIT = 1, it takes up to 1 clock (32.768 kHz) until the counter value can be read or written.
If RSUBC overflows when RWAIT = 1, it counts up after RWAIT = 0. If the second count register is written, however, it does not count up because RSUBC is cleared.

<R> **Caution The RIFG and WAFG flags may be cleared when the RTCC1 register is written by using a 1-bit manipulation instruction. Use, therefore, an 8-bit manipulation instruction in order to write to the RTCC1 register. To prevent the RIFG and WAFG flags from being cleared during writing, disable writing by setting "1" to the corresponding bit. When the value may be rewritten because the RIFG and WAFG flags are not being used, the RTCC1 register may be written by using a 1-bit manipulation instruction.**

Remark Fixed-cycle interrupts and alarm match interrupts use the same interrupt source (INTRTC). When using these two types of interrupts at the same time, which interrupt occurred can be judged by checking the fixed-cycle interrupt status flag (RIFG) and the alarm detection status flag (WAFG) upon INTRTC occurrence.

(7) Minute count register (MIN)

The MIN register is an 8-bit register that takes a value of 0 to 59 (decimal) and indicates the count value of minutes.

It counts up when the second counter overflows.

When data is written to this register, it is written to a buffer and then to the counter up to 2 clocks (32.768 kHz) later. Set a decimal value of 00 to 59 to this register in BCD code. If a value outside this range is set, the register value returns to the normal value after 1 period.

MIN can be set by an 8-bit memory manipulation instruction.

Reset signal generation clears this register to 00H.

Figure 9-8. Format of Minute Count Register (MIN)

Address: FF63H After reset: 00H R/W

Symbol	7	6	5	4	3	2	1	0
MIN	0	MIN40	MIN20	MIN10	MIN8	MIN4	MIN2	MIN1

(8) Hour count register (HOUR)

The HOUR register is an 8-bit register that takes a value of 00 to 23 or 01 to 12, 21 to 32 (decimal) and indicates the count value of hours.

It counts up when the minute counter overflows.

When data is written to this register, it is written to a buffer and then to the counter up to 2 clocks (32.768 kHz) later. Set a decimal value of 00 to 23 or 01 to 12, 21 to 32 to this register in BCD code. If a value outside this range is set, the register value returns to the normal value after 1 period.

HOUR can be set by an 8-bit memory manipulation instruction.

Reset signal generation clears this register to 12H.

However, the value of this register is 00H if the AMPM bit is set to 1 after reset.

Figure 9-9. Format of Hour Count Register (HOUR)

Address: FF64H After reset: 12H R/W

Symbol	7	6	5	4	3	2	1	0
HOUR	0	0	HOUR20	HOUR10	HOUR8	HOUR4	HOUR2	HOUR1

Caution Bit 5 (HOUR20) of HOUR indicates AM(0)/PM(1) if AMPM = 0 (if the 12-hour system is selected).

<R> **(13) Watch error correction register (SUBCUD)**

This register is used to correct the watch with high accuracy when it is slow or fast by changing the value (reference value: 7FFFH) that overflows from the sub-count register (RSUBC) to the second count register.

SUBCUD can be set by an 8-bit memory manipulation instruction.

Reset signal generation clears this register to 00H.

Figure 9-14. Format of Watch Error Correction Register (SUBCUD)

Address: FF82H After reset: 00H R/W

Symbol	7	6	5	4	3	2	1	0
SUBCUD	DEV	F6	F5	F4	F3	F2	F1	F0

DEV	Setting of watch error correction timing
0	Corrects watch error when the second digits are at 00, 20, or 40 (every 20 seconds).
1	Corrects watch error only when the second digits are at 00 (every 60 seconds).

F6	Setting of watch error correction value
0	Increases by {(F5, F4, F3, F2, F1, F0) – 1} × 2.
1	Decreases by {(/F5, /F4, /F3, /F2, /F1, /F0) + 1} × 2.
When (F6, F5, F4, F3, F2, F1, F0) = (*, 0, 0, 0, 0, 0, *), the watch error is not corrected. * is 0 or 1. /F5 to /F0 are the inverted values of the corresponding bits (000011 when 111100). Range of correction value: (when F6 = 0) 2, 4, 6, 8, … , 120, 122, 124 (when F6 = 1) –2, –4, –6, –8, … , –120, –122, –124	

The range of value that can be corrected by using the watch error correction register (SUBCUD) is shown below.

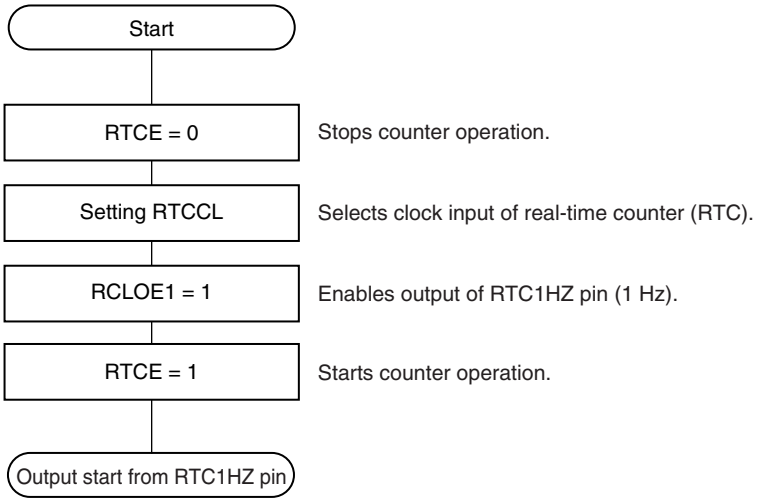
	DEV = 0 (correction every 20 seconds)	DEV = 1 (correction every 60 seconds)
Correctable range	–189.2 ppm to 189.2 ppm	–63.1 ppm to 63.1 ppm
Maximum excludes quantization error	± 1.53 ppm	± 0.51 ppm
Minimum resolution	± 3.05 ppm	± 1.02 ppm

Remark Set DEV to 0 when the correction range is –63.1 ppm or less, or 63.1 ppm or more.

<R> 9.4.5 1 Hz output of real-time counter

Set 1 Hz output after setting 0 to RTCE first.

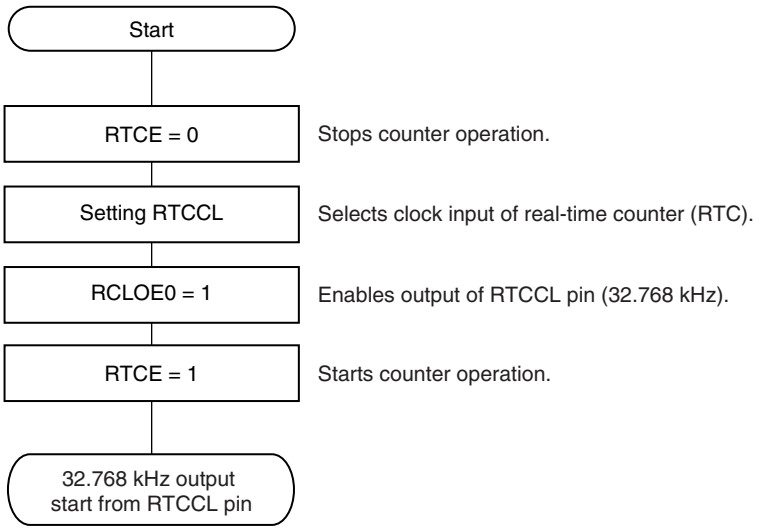
Figure 9-23. 1 Hz Output Setting Procedure



<R> 9.4.6 32.768 kHz output of real-time counter

Set 32.768 kHz output after setting 0 to RTCE first.

Figure 9-24. 32.768 kHz Output Setting Procedure



(2) Serial clock selection register 10 (CSIC10)

This register specifies the timing of the data transmission/reception and sets the serial clock.

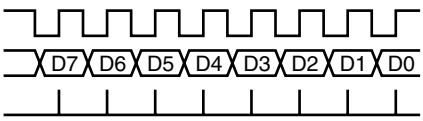
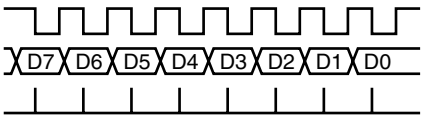
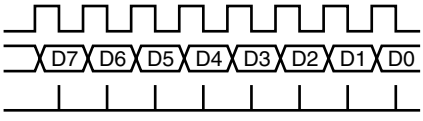
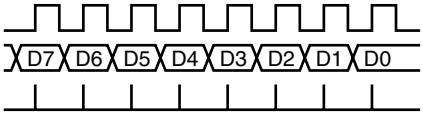
CSIC10 can be set by a 1-bit or 8-bit memory manipulation instruction.

Reset signal generation sets this register to 00H.

Figure 16-3. Format of Serial Clock Selection Register 10 (CSIC10)

Address: FF81H After reset: 00H R/W

Symbol	7	6	5	4	3	2	1	0
CSIC10	0	0	0	CKP10	DAP10	CKS102	CKS101	CKS100

CKP10	DAP10	Specification of data transmission/reception timing	Type
0	0		1
0	1		2
1	0		3
1	1		4

CKS102	CKS101	CKS100	CSI10 serial clock selection[Notes 1, 2]				Mode
				f_{PRS} = 2 MHz	f_{PRS} = 5 MHz	f_{PRS} = 8 MHz	f_{PRS} = 10 MHz	
0	0	0	$f_{PRS}/2$	1 MHz	2.5 MHz	4 MHz	Setting prohibited	Master mode
0	0	1	$f_{PRS}/2^2$	500 kHz	1.25 MHz	2 MHz	2.5 MHz	
0	1	0	$f_{PRS}/2^3$	250 kHz	625 kHz	1 MHz	1.25 MHz	
0	1	1	$f_{PRS}/2^4$	125 kHz	312.5 kHz	500 kHz	625 kHz	
1	0	0	$f_{PRS}/2^5$	62.5 kHz	156.25 kHz	250 kHz	312.5 kHz	
1	0	1	$f_{PRS}/2^6$	31.25 kHz	78.13 kHz	125 kHz	156.25 kHz	
1	1	0	$f_{PRS}/2^7$	15.63 kHz	39.06 kHz	62.5 kHz	78.13 kHz	
1	1	1	External clock input to $\overline{SCK10}$					Slave mode

Notes 1. If the peripheral hardware clock (f_{PRS}) operates on the high-speed system clock (f_{XH}) (XSEL = 1), the f_{PRS} operating frequency varies depending on the supply voltage.

- V_{DD} = 2.7 to 5.5 V: $f_{PRS} \leq$ 10 MHz
- V_{DD} = 1.8 to 2.7 V: $f_{PRS} \leq$ 5 MHz

(c) Repeat transmission mode

In this mode, data stored in the internal buffer RAM is transmitted repeatedly.

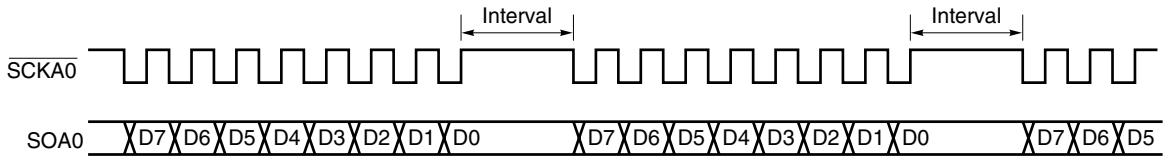
Serial communication is started when bit 0 (ATSTA0) of serial trigger register 0 (CSIT0) is set to 1 while bit 7 (CSIAE0), bit 6 (ATE0), bit 5 (ATM0), and bit 3 (TXEA0) of serial operation mode specification register 0 (CSIMA0) are set to 1.

Unlike the automatic transmission mode, after the number of setting bytes has been transmitted, the interrupt request flag (ACSIIF) is not set, automatic data transfer address count register 0 (ADTC0) is reset to 0, and the internal buffer RAM contents are transmitted again.

When a reception operation, busy control and strobe control are not performed, the SIA0/P15 pin can be used as ordinary I/O port pins.

The example of the repeat transmission mode operation timing is shown in Figure 17-20, and the operation flowchart in Figure 17-21.

Figure 17-20. Example of Repeat Transmission Mode Operation Timing



Cautions 1. Because, in the repeat transmission mode, a read is performed on the buffer RAM after the transmission of one byte, the interval is included in the period up to the next transmission. As the buffer RAM read is performed at the same time as CPU processing, the interval is dependent upon the set value of automatic data transfer interval specification register 0 (ADTI0).

2. If an access to the buffer RAM by the CPU conflicts with an access to the buffer RAM by serial interface CSIA0 during the interval period, the interval time specified by automatic data transfer interval specification register 0 (ADTI0) may be extended.

18.7.5 Eight-time-slice display example

Figure 18-31 shows how the 15×8 dots LCD panel having the display pattern shown in Figure 18-30 is connected to the segment signals (SEG4 to SEG18) and the common signals (COM0 to COM7) of the 78K0/LF3 chip. This example displays data "123" in the LCD panel. The contents of the display data memory (addresses FA44H to FA52H) correspond to this display.

The following description focuses on numeral "3." (∃) displayed in the first digit. To display "3." in the LCD panel, it is necessary to apply the select or deselect voltage to the SEG4 and SEG8 pins according to Table 18-10 at the timing of the common signals COM0 to COM7; see Figure 18-30 for the relationship between the segment signals and LCD segments.

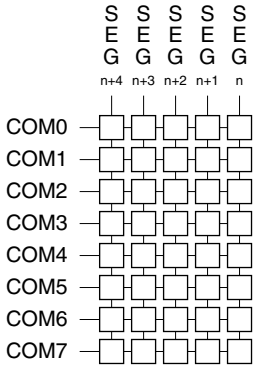
Table 18-10. Select and Deselect Voltages (COM0 to COM7)

Segment / Common	SEG4	SEG5	SEG6	SEG7	SEG8
COM0	Select	Select	Select	Select	Select
COM1	Deselect	Select	Deselect	Deselect	Deselect
COM2	Deselect	Deselect	Select	Deselect	Deselect
COM3	Deselect	Select	Deselect	Deselect	Deselect
COM4	Select	Deselect	Deselect	Deselect	Deselect
COM5	Select	Deselect	Deselect	Deselect	Select
COM6	Deselect	Select	Select	Select	Deselect
COM7	Deselect	Deselect	Deselect	Deselect	Deselect

According to Table 18-10, it is determined that the display data memory location (FA44H) that corresponds to SEG4 must contain 00110001.

Figure 18-32 shows examples of LCD drive waveforms between the SEG4 signal and each common signal. When the select voltage is applied to SEG4 at the timing of COM0, a waveform is generated to turn on the corresponding LCD segment.

Figure 18-30. Eight-Time-Slice LCD Display Pattern and Electrode Connections



<2> Error of baud rate

The baud rate error can be calculated by the following expression.

- $\text{Error (\%)} = \left(\frac{\text{Actual baud rate (baud rate with error)}}{\text{Desired baud rate (correct baud rate)}} - 1 \right) \times 100 \text{ [\%]}$

Caution Keep the baud rate error during transmission to within the permissible error range at the reception destination.

Example: Frequency of base clock = 2.5 MHz = 2,500,000 Hz
Set value of MC0BRS4 to MC0BRS0 bits of MC0CTL2 register = 10000B (k = 16)
Target baud rate = 76,800 bps

Baud rate = 2.5 M/(2 × 16)
= 2,500,000/(2 × 16) = 78125 [bps]

Error = (78,125/76,800 − 1) × 100
= 1.725 [%]

<3> Example of setting baud rate

Baud Rate [bps]	f_{PRS} = 10.0 MHz				f_{PRS} = 8.38 MHz				f_{PRS} = 8.0 MHz				f_{PRS} = 6.0 MHz			
	MC0CKS2 to MC0CKS0	k	Calculated Value	ERR [%]	MC0CKS2 to MC0CKS0	k	Calculated Value	ERR [%]	MC0CKS2 to MC0CKS0	k	Calculated Value	ERR [%]	MC0CKS2 to MC0CKS0	k	Calculated Value	ERR [%]
4800	–	–	–	–	5, 6, or 7	27	4850	1.03	5, 6, or 7	26	4808	0.16	5, 6, or 7	20	4688	–2.34
9600	5, 6, or 7	16	9766	1.73	4	27	9699	1.03	5, 6, or 7	13	9615	0.16	4	20	9375	–2.34
19200	5	8	19531	1.73	3	27	19398	1.03	4	13	19231	0.16	4	10	18750	–2.34
31250	4	10	31250	0	2	17	30809	–1.41	4	8	31250	0	2	24	31250	0
38400	4	8	39063	1.73	2	27	38796	1.03	3	13	38462	0.16	2	20	37500	–2.34
56000	3	11	56818	1.46	2	19	55132	–1.55	3	9	55556	–0.79	1	27	55556	–0.79
62500	2	20	62500	0	2	17	61618	–1.41	3	8	62500	0	2	12	62500	0
76800	2	16	78125	1.73	1	27	77592	1.03	2	13	76923	0.16	2	10	75000	–2.34
115200	1	22	113636	–1.36	2	9	116389	1.03	1	17	117647	2.12	1	13	115385	0.16
125000	1	20	125000	0	1	17	123235	–1.41	1	16	125000	0	1	12	125000	0
153600	1	16	156250	1.73	2	7	149643	–2.58	1	13	153846	0.16	1	10	150000	–2.34
250000	1	10	250000	0	1	8	261875	4.75	1	8	250000	0	1	6	250000	0
					0	17	246471	–1.41								

Remark MC0CKS2 to MC0CKS0: Bits 2 to 0 of MCG control register 1 (MC0CTL1) (setting of base clock (f_{XCLK}))
k: Value set by bits 4 to 0 (MC0BRS4 to MC0BRS0) of MCG control register 2 (MC0CTL2) (k = 4, 5, 6, …, 31)
f_{PRS}: Peripheral hardware clock frequency
ERR: Baud rate error

(12) Remote controller receive DH1S compare register (RMDH1S)

This register is used to detect the high level of remote controller data 1 (short side).

RMDH1S is set with an 8-bit memory manipulation instruction.

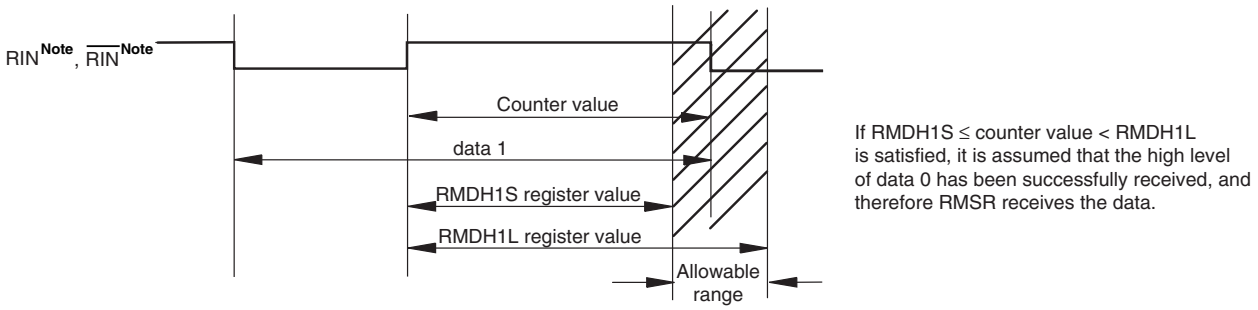
Reset signal generation sets RMDH1S to 00H.

(13) Remote controller receive DH1L compare register (RMDH1L)

This register is used to detect the high level of remote controller data 1 (long side).

RMDH1L is set with an 8-bit memory manipulation instruction.

Reset signal generation sets RMDH1L to 00H.



Note RIN is generated in type A reception mode, and $\overline{\text{RIN}}$ is generated in type B and type C reception modes.

(2) Interrupt mask flag registers (MK0L, MK0H, MK1L, MK1H)

The interrupt mask flags are used to enable/disable the corresponding maskable interrupt servicing.

MK0L, MK0H, MK1L, and MK1H are set by a 1-bit or 8-bit memory manipulation instruction. When MK0L and MK0H, and MK1L and MK1H are combined to form 16-bit registers MK0 and MK1, they are set by a 16-bit memory manipulation instruction.

Reset signal generation sets these registers to FFH.

Figure 21-3. Format of Interrupt Mask Flag Registers (MK0L, MK0H, MK1L, MK1H)

Address: FFE4H After reset: FFH R/W

Symbol	<7>	<6>	<5>	<4>	<3>	<2>	<1>	<0>
MK0L	SREMK6	PMK5	PMK4	PMK3	PMK2	PMK1	PMK0	LVIMK

Address: FFE5H After reset: FFH R/W

Symbol	<7>	<6>	<5>	<4>	<3>	<2>	<1>	<0>
MK0H	TMMK010	TMMK000	TMMK50	TMMKH0	TMMKH1	CSIMK10 STMK0	STMK6	SRMK6

Address: FFE6H After reset: FFH R/W

Symbol	<7>	<6>	<5>	<4>	<3>	<2>	<1>	<0>
<R> MK1L	TMMK52	DASDMK[Note 2]	RTCIMK	KRMK	TMMK51	RTCMK	SRMK0	ADMK[Note 1]

Address: FFE7H After reset: FFH R/W

Symbol	7	6	5	<4>	<3>	<2>	<1>	<0>
MK1H	1	1	1	ACSIMK	RERRMK GPMK RENDMK DFULLMK	RINMK	MCGMK	TMHMK2

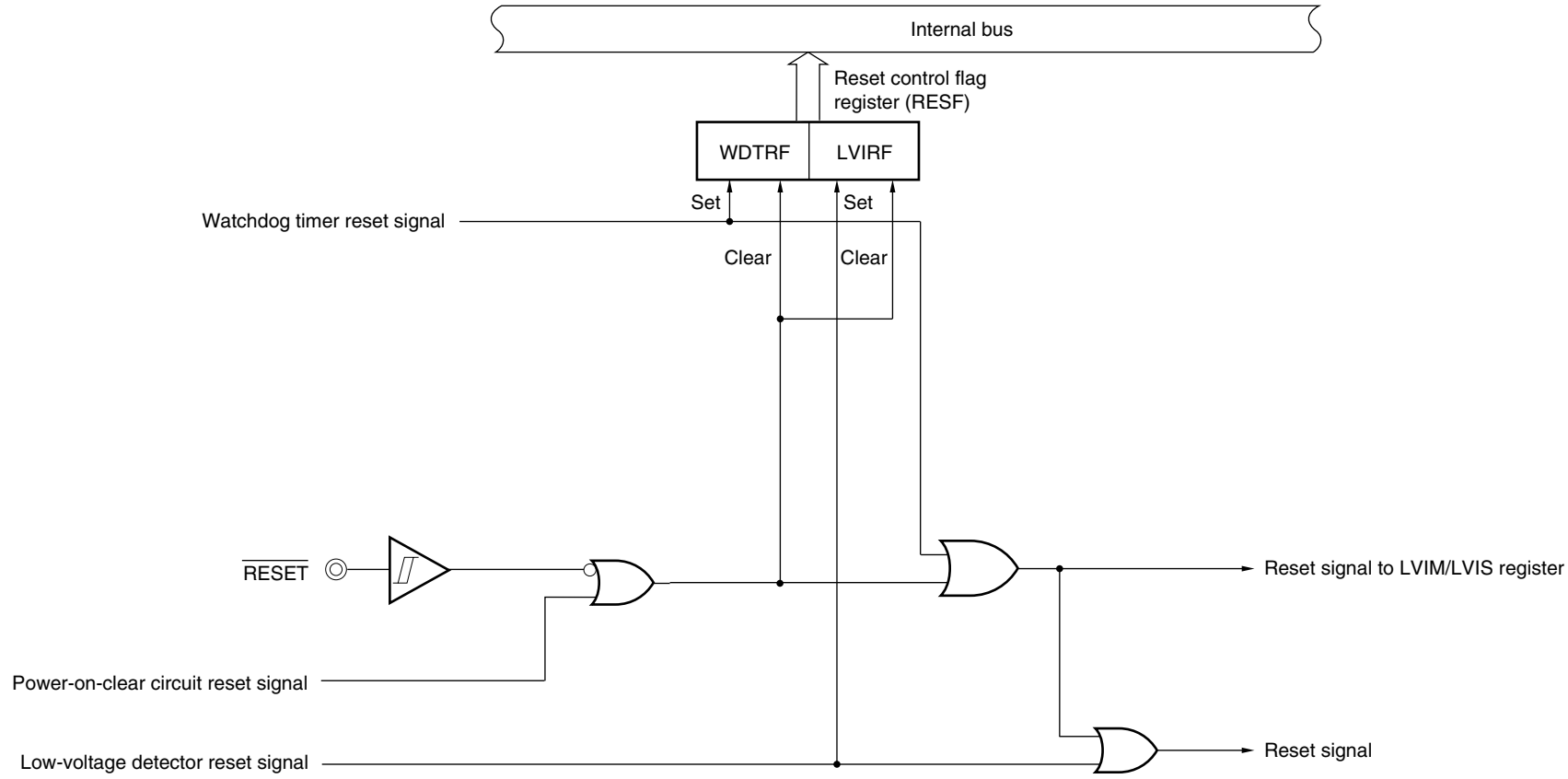
XXMKX	Interrupt servicing control
0	Interrupt servicing enabled
1	Interrupt servicing disabled

Notes 1. μPD78F048x and 78F049x only.

2. μPD78F049x only.

Caution Be sure to set bits 5 to 7 of MK1H to 1.

Figure 24-1. Block Diagram of Reset Function



Caution An LVI circuit internal reset does not reset the LVI circuit.

Remarks 1. LVIM: Low-voltage detection register

2. LVIS: Low-voltage detection level selection register